

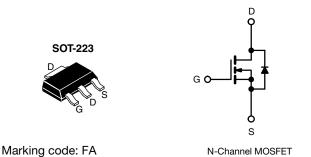
Vishay Siliconix

HALOGEN

FREE

Power MOSFET

PRODUCT SUMMA	RY	
V _{DS} (V)	60	
$R_{DS(on)}(\Omega)$	V _{GS} = 10 V	0.20
Q _g max. (nC)	11	
Q _{gs} (nC)	3.1	
Q _{gd} (nC)	5.8	1
Configuration	Sing	le



FEATURES

- Surface mount
- Available in tape and reel
- Dynamic dV/dt rating
- · Fast switching
- Ease of paralleling
- Simple drive requirements
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

DESCRIPTION

Third generation power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The SOT-223 package is designed for surface-mounting using vapor phase, infrared, or wave soldering techniques. Its unique package design allows for easy automatic pick-and-place as with other SOT or SOIC packages but has the added advantage of improved thermal performance due to an enlarged tab for heatsinking. Power dissipation of greater than 1.25 W is possible in a typical surface mount application.

ORDERING INFORMATION	
Package	SOT-223
Lead (Pb)-free and Halogen-free	SiHFL014TR-GE3 a
Lead (Pb)-free	IRFL014TRPbF ^a

Note

a. See device orientation.

ABSOLUTE MAXIMUM RATINGS (T _C	= 25 °C, unl	ess otherwis	se noted)			
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-Source Voltage		V_{DS}	60	V		
Gate-Source Voltage			V_{GS}	± 20		
Continuous Drain Current	V _{GS} at 10 V	$T_C = 25 ^{\circ}C$ $T_C = 100 ^{\circ}C$		2.7		
Continuous Drain Current	V _{GS} at 10 V	T _C = 100 °C	I _D	1.7	Α	
Pulsed Drain Current ^a			I _{DM}	22		
Linear Derating Factor				0.025	W//9C	
Linear Derating Factor (PCB mount) e				0.017	W/°C	
Single Pulse Avalanche Energy b			E _{AS}	100	mJ	
Maximum Power Dissipation	T _C =	25 °C	ם	3.1	w	
Maximum Power Dissipation (PCB mount) e	T _A =	25 °C	P_{D}	2.0		
Peak Diode Recovery dV/dt ^c		dV/dt	4.5	V/ns		
Operating Junction and Storage Temperature Rang	е)		-55 to +150		
Soldering Recommendations (Peak temperature) d	for	10 s		300	°C	

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b. $V_{DD} = 25 \text{ V}$, starting $T_J = 25 \,^{\circ}\text{C}$, $L = 16 \, \text{mH}$, $R_g = 25 \, \Omega$, $I_{AS} = 2.7 \, \text{A}$ (see fig. 12).
- c. $I_{SD} \le 10$ A, $dI/dt \le 90$ A/µs, $V_{DD} \le V_{DS}$, $T_J \le 150$ °C.
- d. 1.6 mm from case.
- e. When mounted on 1" square PCB (FR-4 or G-10 material).



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THERMAL RESISTANCE RAT	INGS				
PARAMETER	SYMBOL	MIN.	TYP.	MAX.	UNIT
Maximum Junction-to-Ambient (PCB mount) ^a	R _{thJA}	-	-	60	°C/W
Maximum Junction-to-Case (Drain)	R _{thJC}	-	-	40	

Note

a. When mounted on 1" square PCB (FR-4 or G-10 material).

PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static					L		
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} =	= 0 V, I _D = 250 μA	60	-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference	e to 25 °C, I _D = 1 mA	-	0.068	-	V/°C
Gate-Source Threshold Voltage	V _{GS(th)}	V _{DS} =	= V _{GS} , I _D = 250 μA	2.0	-	4.0	V
Gate-Source Leakage	I _{GSS}	,	V _{GS} = ± 20 V	-	-	± 100	nA
Zero Gate Voltage Drain Current	I _{DSS}		= 60 V, V _{GS} = 0 V , V _{GS} = 0 V, T _J = 125 °C	-	-	25 250	μA
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 1.6 A ^b	-	-	0.20	Ω
Forward Transconductance	9 _{fs}	V _{DS}	= 25 V, I _D = 1.6 A	1.9	-	-	S
Dynamic		^		•			·
Input Capacitance	C _{iss}	$V_{GS} = 0 \text{ V},$ $V_{DS} = 25 \text{ V},$		-	300	-	pF
Output Capacitance	C _{oss}			-	160	-	
Reverse Transfer Capacitance	C _{rss}	f = 1.	.0 MHz, see fig. 5	-	29	-	1
Total Gate Charge	Qg			-	-	11	
Gate-Source Charge	Q _{gs}	V _{GS} = 10 V	$I_D = 10 \text{ A}, V_{DS} = 48 \text{ V},$ see fig. 6 and 13 b		-	3.1	nC
Gate-Drain Charge	Q _{gd}		occ lig. o and ro	-	-	5.8	
Turn-On Delay Time	t _{d(on)}			-	10	-	
Rise Time	t _r	V _{DD} :	= 30 V, I _D = 10 A,	-	50	-	no
Turn-Off Delay Time	t _{d(off)}	$V_{DD} = 30 \text{ V, } I_{D} = 10 \text{ A,}$ $R_{g} = 24 \Omega, R_{D} = 2.7 \Omega, \text{ see fig. } 10^{\text{ b}}$ $ -$		ns			
Fall Time	t _f			-	19	-	1
Internal Drain Inductance	L _D	Between lead, - 4.0 - 6 mm (0.25") from		الم			
Internal Source Inductance	L _S	package and die contact	center of	-	6.0	-	- nH
Drain-Source Body Diode Characteristic	s						
Continuous Source-Drain Diode Current	Is	MOSFET symbol showing the		-	-	2.7	A
Pulsed Diode Forward Current ^a	I _{SM}	integral revers p - n junction		-	-	22	_ ^
Body Diode Voltage	V _{SD}	T _J = 25 °C	, I _S = 2.7 A, V _{GS} = 0 V ^b	-	-	1.6	V
Body Diode Reverse Recovery Time	t _{rr}	T 05 °C 1	10 A 41/4+ 100 A /··- h	-	70	140	ns
Body Diode Reverse Recovery Charge	Q _{rr}	$\int_{-1}^{1} I_{J} = 25 \text{ °C, } I_{F}$	= 10 A, dl/dt = 100 A/µs b	-	0.20	0.40	μC
Forward Turn-On Time	t _{on}	Intrinsic tu	ırn-on time is negligible (turn	-on is dor	ninated b	v L _s and	L _D)

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b. Pulse width \leq 300 μ s; duty cycle \leq 2 %.



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

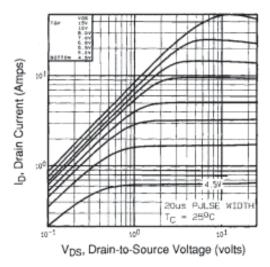


Fig. 1 - Typical Output Characteristics, T_C = 25 °C

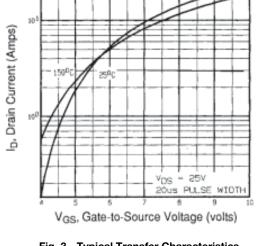


Fig. 3 - Typical Transfer Characteristics

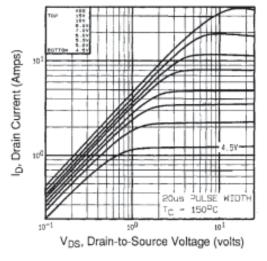


Fig. 2 - Typical Output Characteristics, $T_C = 150$ °C

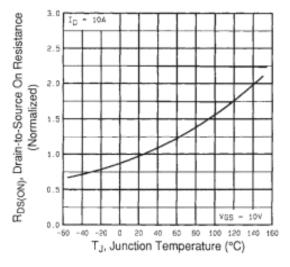


Fig. 4 - Normalized On-Resistance vs. Temperature



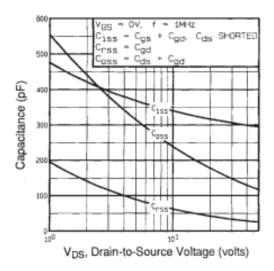


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

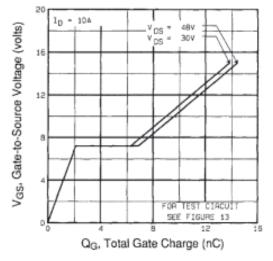


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

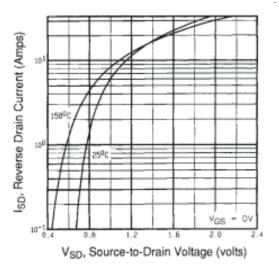


Fig. 7 - Typical Source-Drain Diode Forward Voltage

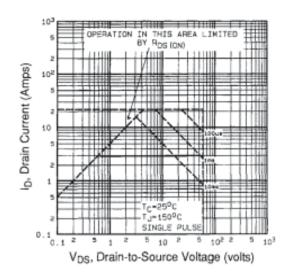


Fig. 8 - Maximum Safe Operating Area



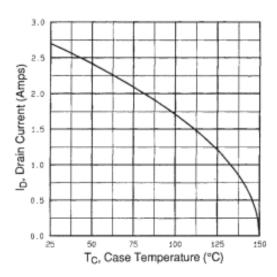


Fig. 9 - Maximum Drain Current vs. Case Temperature

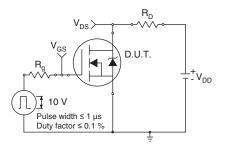


Fig. 10a -Switching Time Test Circuit

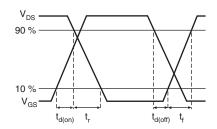


Fig. 10b -Switching Time Waveforms

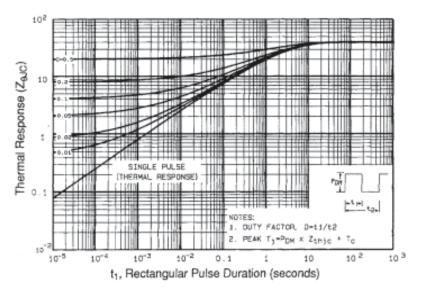


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case



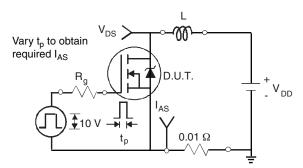


Fig. 12a - Unclamped Inductive Test Circuit

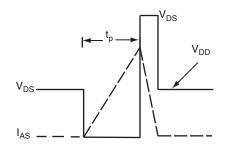


Fig. 12b - Unclamped Inductive Waveforms

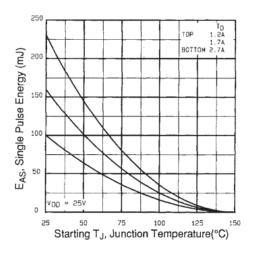


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

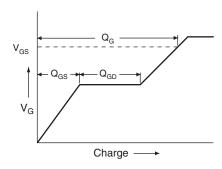


Fig. 13a - Basic Gate Charge Waveform

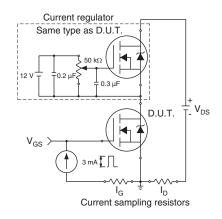
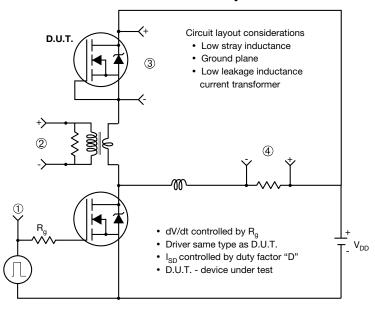


Fig. 13b - Gate Charge Test Circuit



Peak Diode Recovery dV/dt Test Circuit



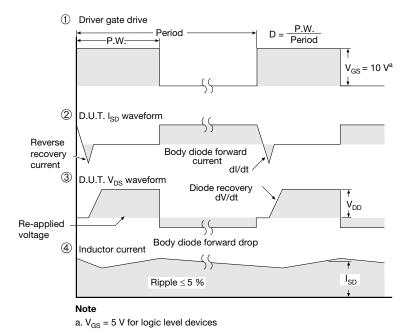


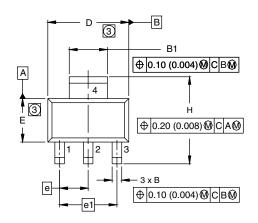
Fig. 12 - For N-Channel

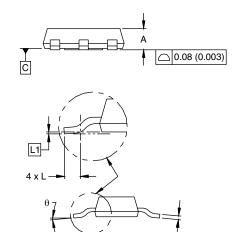
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Vishay Siliconix

SOT-223 (HIGH VOLTAGE)





DIM.	MILLI	METERS	INCHES		
	MIN.	MAX.	MIN.	MAX.	
Α	1.55	1.80	0.061	0.071	
В	0.65	0.85	0.026	0.033	
B1	2.95	3.15	0.116	0.124	
С	0.25	0.35	0.010	0.014	
D	6.30	6.70	0.248	0.264	
E	3.30	3.70	0.130	0.146	
е	2.30 BSC		0.0905 BSC		
e1	4.60 BSC		0.181	BSC	
Н	6.71	7.29	0.264	0.287	
L	0.91	-	0.036	=	
L1	0.061 BSC		0.0024	BSC	
θ	-	10'	-	10'	

ECN: S-82109-Rev. A, 15-Sep-08

DWG: 5969

Notes

- 1. Dimensioning and tolerancing per ASME Y14.5M-1994.
- 2. Dimensions are shown in millimeters (inches).
- 3. Dimension do not include mold flash.
- 4. Outline conforms to JEDEC outline TO-261AA.



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